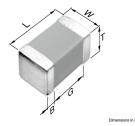
## **<b>&TDK** Multilayer Ceramic Chip Capacitors

### C2012C0G2W272J125AA



### TDK item description C2012C0G2W272JT\*\*\*\*

Applications	Commercial Grade	
Feature	Mid Voltage (100 to 630V)	
Series	C2012 [EIA 0805]	
Status	Production	



	Size
Length(L)	2.00mm ±0.20mm
Width(W)	1.25mm ±0.20mm
Thickness(T)	1.25mm ±0.20mm
Terminal Width(B)	0.20mm Min.
Terminal Spacing(G)	
Recommended Land Pattern (PA)	1.00mm to 1.30mm(Flow Soldering)
	0.90mm to 1.20mm(Reflow Soldering)
Recommended Land Pattern (PB)	1.00mm to 1.20mm(Flow Soldering)
	0.70mm to 0.90mm(Reflow Soldering)
Recommended Land Pattern (PC)	0.80mm to 1.10mm(Flow Soldering)
	0.90mm to 1.20mm(Reflow Soldering)

Electrical Characteristics		
Capacitance	2.7nF ±5%	
Rated Voltage	450VDC	
Temperature Characteristic	C0G(0±30ppm/°C)	
Q (Min.)	1000	
Insulation Resistance (Min.)	10000ΜΩ	

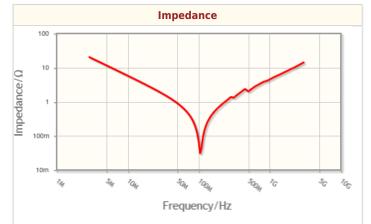
Other		
Soldering Method	Wave (Flow)	
	Reflow	
AEC-Q200	No	
Packing	Blister (Plastic)Taping [180mm Reel]	
Package Quantity	2000pcs	

! Images are for reference only and show exemplary products. ! This PDF document was created based on the data listed on the TDK Corporation website.

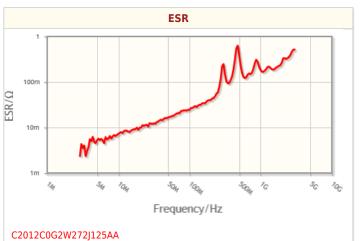
! All specifications are subject to change without notice.

### C2012C0G2W272J125AA

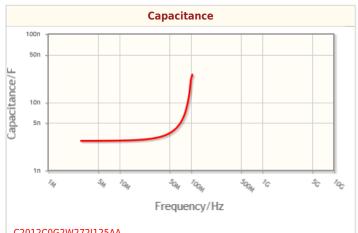


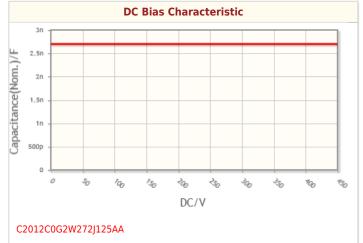


# Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

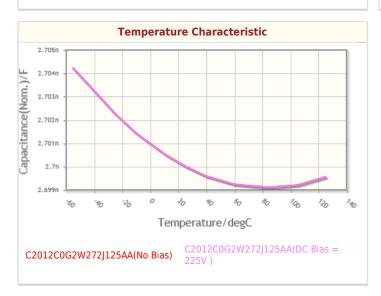


#### C2012C0G2W272J125AA





#### C2012C0G2W272J125AA



! Images are for reference only and show exemplary products.

! This PDF document was created based on the data listed on the TDK Corporation website.

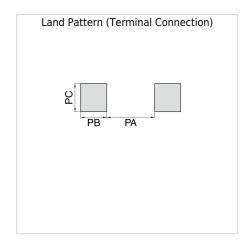
! All specifications are subject to change without notice.

Copyright(c) TDK Corporation. All rights reserved.

## C2012C0G2W272J125AA



## Associated Images



! Images are for reference only and show exemplary products.

! This PDF document was created based on the data listed on the TDK Corporation website.

! All specifications are subject to change without notice.